



DCR2880B65

Phase Control Thyristor

DS5786-4 April 2013 (LN30262)

FEATURES

- Double Side Cooling
- High Surge Capability

APPLICATIONS

- High Power Drives
- High Voltage Power Supplies
- Static Switches

VOLTAGE RATINGS

| Part and Ordering Number | Repetitive Peak Voltages V _{DRM} and V _{RRM} V | Conditions |
|-------------------------------------------------------|---------------------------------------------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| DCR2880B65* DCR2880B60 DCR2880B55 DCR2880B50 | 6500 6000 5500 5000 | $\begin{split} T_{vj} &= \text{-}40^{\circ}\text{C to 125}^{\circ}\text{C}, \\ I_{DRM} &= I_{RRM} = 300\text{mA}, \\ V_{DRM}, V_{RRM} t_p &= 10\text{ms}, \\ V_{DSM} \& V_{RSM} &= \\ V_{DRM} \& V_{RRM} + 100V \\ respectively \end{split}$ |

Lower voltage grades available. *6200V @ -40°C, 6500V@ 0°C

ORDERING INFORMATION

When ordering, select the required part number shown in the Voltage Ratings selection table.

For example:

DCR2880B65

Note: Please use the complete part number when ordering and quote this number in any future correspondence relating to your order.

KEY PARAMETERS

| V_{DRM} | 6500V |
|------------------|----------|
| $I_{T(AV)}$ | 2845A |
| I _{TSM} | 38500A |
| dV/dt* | 1500V/μs |
| dI/dt | 300A/μs |

* Higher dV/dt selections available

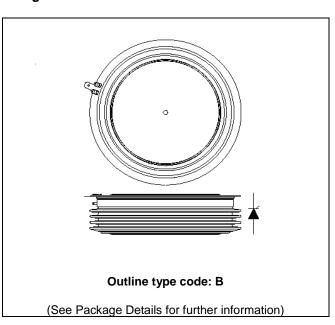


Fig. 1 Package outline



CURRENT RATINGS

$T_{case} = 60$ °C unless stated otherwise

| Symbol | Parameter | Test Conditions | Max. | Units |
|---------------------|--------------------------------------|--------------------------|------|-------|
| Double Sid | de Cooled | | | |
| I _{T(AV)} | Mean on-state current | Half wave resistive load | 2845 | А |
| I _{T(RMS)} | RMS value | - | 4469 | А |
| I _T | Continuous (direct) on-state current | - | 4130 | А |

SURGE RATINGS

| Symbol | Parameter | Test Conditions | Max. | Units |
|------------------|-----------------------------------------|-------------------------------------------|-------|-------------------|
| I _{TSM} | Surge (non-repetitive) on-state current | 10ms half sine, T _{case} = 125°C | 38.85 | kA |
| l ² t | I ² t for fusing | $V_R = 0$ | 7.55 | MA ² s |

THERMAL AND MECHANICAL RATINGS

| Symbol | Parameter | Test Conditions | | Min. | Max. | Units |
|----------------------|---------------------------------------|----------------------------------------------|-------------|------|--------|-------|
| R _{th(j-c)} | Thermal resistance – junction to case | Double side cooled DC | | - | 0.007 | °C/W |
| | | Single side cooled | Anode DC | - | 0.0116 | °C/W |
| | | | Cathode DC | - | 0.0181 | °C/W |
| R _{th(c-h)} | Thermal resistance – case to heatsink | Clamping force 76.0kN | Double side | - | 0.0014 | °C/W |
| | | (with mounting compound) | Single side | - | 0.0028 | °C/W |
| T_{vj} | Virtual junction temperature | Blocking V _{DRM} / V _{RRM} | | - | 125 | °C |
| T _{stg} | Storage temperature range | | | -55 | 125 | °C |
| F _m | Clamping force | | | 68.0 | 84.0 | kN |





DYNAMIC CHARACTERISTICS

| Symbol | Parameter | Test Conditio | Test Conditions | | Max. | Units |
|------------------------------------|-----------------------------------------------|-------------------------------------------------------------------|-----------------|------|-------|-------|
| I _{RRM} /I _{DRM} | Peak reverse and off-state current | At V _{RRM} /V _{DRM} , T _{case} = 125°C | | - | 300 | mA |
| dV/dt | Max. linear rate of rise of off-state voltage | To 67% V_{DRM} , $T_j = 125$ °C, ga | ate open | - | 1500 | V/µs |
| dl/dt | Rate of rise of on-state current | From 67% V _{DRM} to 2x I _{T(AV)} | Repetitive 50Hz | - | 150 | A/µs |
| | | Gate source 30V, 10Ω, | Non-repetitive | - | 300 | A/µs |
| | | $t_r < 0.5 \mu s, T_j = 125^{\circ}C$ | | | | |
| V _{T(TO)} | Threshold voltage – Low level | 500 to 2400A at T _{case} = 125° | С | - | 0.94 | V |
| | Threshold voltage – High level | 2400 to 7200A at T _{case} = 125°C | | - | 1.13 | ٧ |
| r _T | On-state slope resistance – Low level | 500A to 2400A at T _{case} = 125°C | | - | 0.343 | mΩ |
| | On-state slope resistance – High level | 2400A to 7200A at T _{case} = 125°C | | - | 0.264 | mΩ |
| t _{gd} | Delay time | $V_D = 67\% V_{DRM}$, gate source 30V, 10Ω | | - | 3 | μs |
| | | $t_r = 0.5 \mu s, T_j = 25^{\circ}C$ | | | | |
| tq | Turn-off time | $T_j = 125$ °C, $V_R = 200$ V, $dI/dt = 1$ A/ μ s, | | - | 1200 | μs |
| | | dV _{DR} /dt = 20V/μs linear | | | | |
| Qs | Stored charge | $I_T = 2000A$, $T_j = 125$ °C, $dI/dt - 1A/\mu s$, | | 2800 | 6400 | μC |
| IL | Latching current | $T_j = 25^{\circ}C, V_D = 5V$ | | - | 3 | А |
| I _H | Holding current | $T_j = 25$ °C, $R_{G-K} = \infty$, $I_{TM} = 500$ A, $I_T = 5$ A | | - | 300 | mA |



GATE TRIGGER CHARACTERISTICS AND RATINGS

| Symbol | Parameter | Test Conditions | Max. | Units |
|-----------------|--------------------------|-----------------------------------------------------|------|-------|
| V_{GT} | Gate trigger voltage | $V_{DRM} = 5V$, $T_{case} = 25$ °C | 1.5 | V |
| V_{GD} | Gate non-trigger voltage | At 50% V _{DRM} , T _{case} = 125°C | 0.4 | V |
| I _{GT} | Gate trigger current | $V_{DRM} = 5V$, $T_{case} = 25$ °C | 400 | mA |
| I _{GD} | Gate non-trigger current | At 50% V _{DRM} , T _{case} = 125°C | 10 | mA |

CURVES

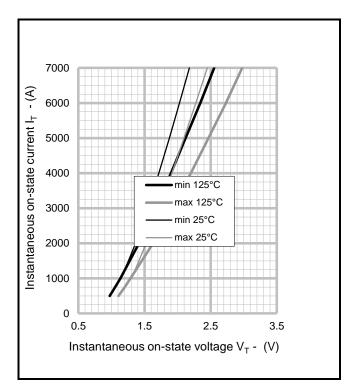


Fig.2 Maximum & minimum on-state characteristics

V_{TM} EQUATION

 $V_{TM} = A + Bln (I_T) + C.I_T + D.\sqrt{I_T}$

Where A = 0.914146

B = -0.03808

C = 0.00016

D = 0.015311

these values are valid for $T_j = 125$ °C for $I_T 500A$ to 7200A

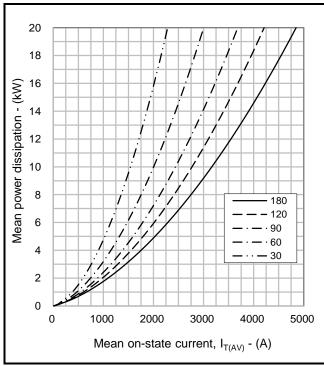


Fig.3 On-state power dissipation - sine wave

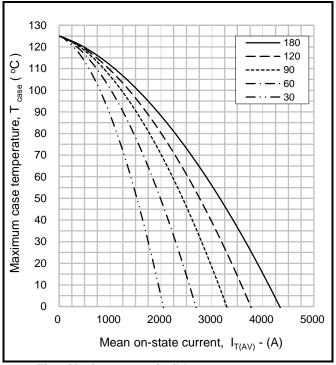


Fig.4 Maximum permissible case temperature, double side cooled – sine wave

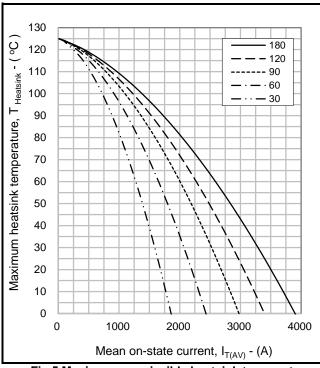


Fig.5 Maximum permissible heatsink temperature, double side cooled – sine wave

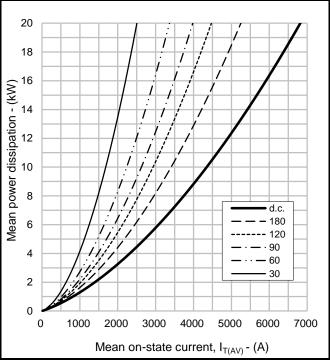


Fig.6 On-state power dissipation - rectangular wave

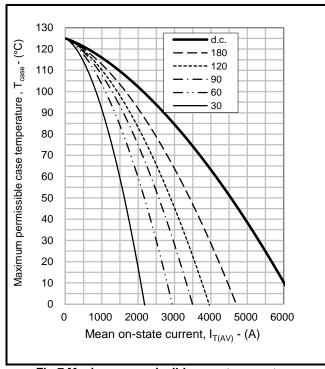


Fig.7 Maximum permissible case temperature, double side cooled – rectangular wave

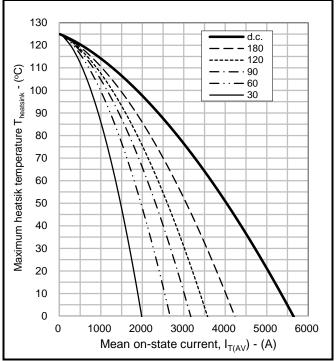
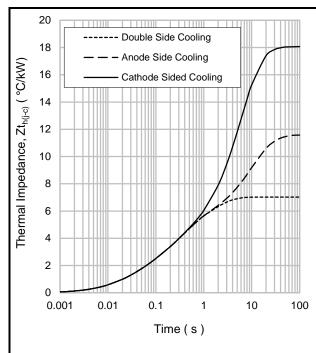


Fig.8 Maximum permissible heatsink temperature, double side cooled – rectangular wave



| | | 1 | 2 | 3 | 4 |
|---------------------|------------------------|-----------|-----------|-----------|--------|
| Double side cooled | R _i (°C/kW) | 0.502 | 1.333 | 2.9559 | 2.2335 |
| | T _i (s) | 0.0137081 | 0.0548877 | 0.3311925 | 1.6905 |
| Anode side cooled | R _i (°C/kW) | 1.3035 | 3.138 | 1.1859 | 5.9136 |
| | T _i (s) | 0.0251065 | 0.2410256 | 1.0806 | 11.002 |
| Cathode side cooled | R _i (°C/kW) | 1.2616 | 2.6216 | 13.3603 | 0.8304 |
| | T; (s) | 0.0245837 | 0.2005035 | 5 7854 | 16 765 |

 $Z_{th} = \sum [R_i x (1-exp. (t/t_i))]$ [1]

 $\Delta R_{\text{th(j-c)}}$ Conduction

Tables show the increments of thermal resistance $R_{\text{th}(j-c)}$ when the device operates at conduction angles other than d.c.

| Double side cooling | | | | Anode Side Cooling | | |
|---------------------|--------------------|-------|--|--------------------|------------------|-------|
| | $\Delta Z_{th}(z)$ | | | | _h (z) | |
| θ° | sine. | rect. | | θ° | sine. | rect. |
| 180 | 0.70 | 0.48 | | 180 | 0.67 | 0.47 |
| 120 | 0.80 | 0.68 | | 120 | 0.77 | 0.66 |
| 90 | 0.90 | 0.78 | | 90 | 0.87 | 0.75 |
| 60 | 1.00 | 0.89 | | 60 | 0.95 | 0.86 |
| 30 | 1.07 | 1.01 | | 30 | 1.02 | 0.96 |
| 15 | 1.10 | 1.07 | | 15 | 1.05 | 1.02 |

| Cathode Sided Cooling | | | | |
|-----------------------|--------------------|-------|--|--|
| | $\Delta Z_{th}(z)$ | | | |
| θ° | sine. | rect. | | |
| 180 | 0.67 | 0.47 | | |
| 120 | 0.77 | 0.66 | | |
| 90 | 0.87 | 0.76 | | |
| 60 | 0.95 | 0.86 | | |
| 30 | 1.02 | 0.96 | | |
| 15 | 1.05 | 1.02 | | |

Fig.9 Maximum (limit) transient thermal impedance - junction to case (°C/kW)

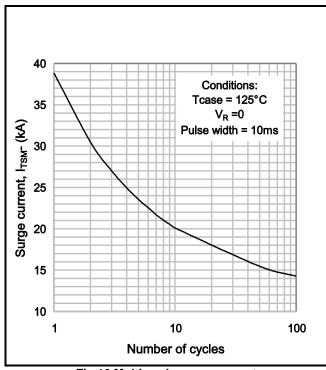


Fig.10 Multi-cycle surge current

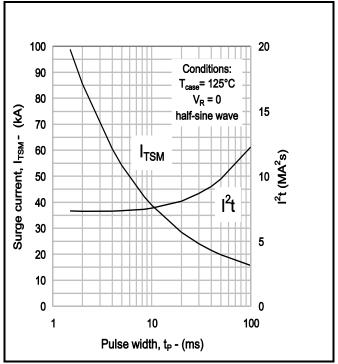


Fig.11 Single-cycle surge current

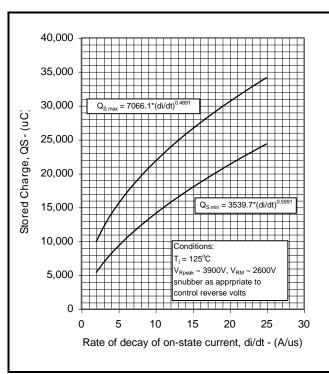


Fig.10 Reverse recovery charge

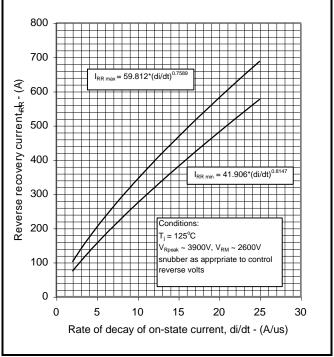


Fig.11 Reverse recovery current

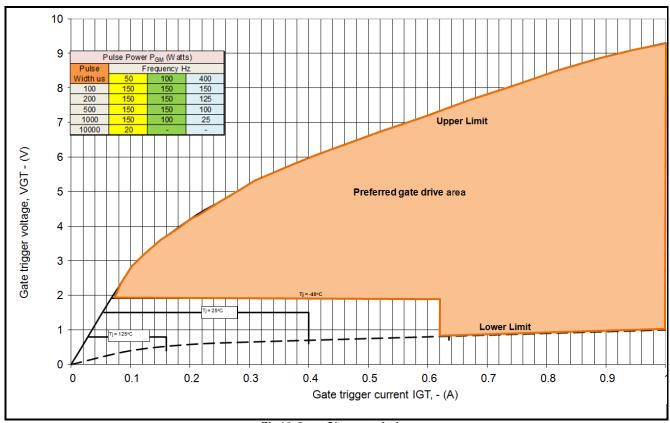


Fig12 Gate Characteristics

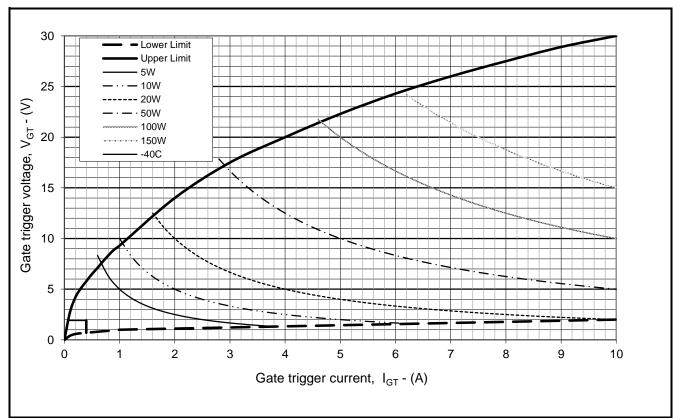


Fig. 13 Gate characteristics



PACKAGE DETAILS

For further package information, please contact Customer Services. All dimensions in mm, unless stated otherwise. DO NOT SCALE.

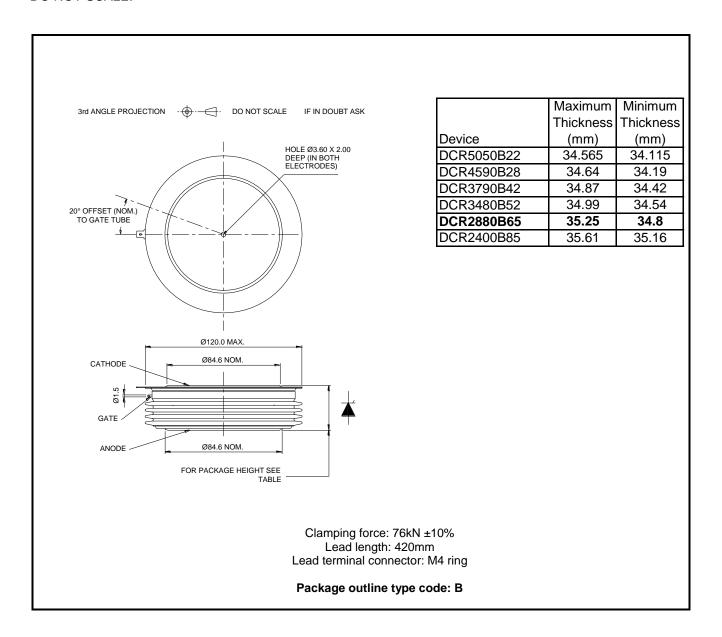


Fig.14 Package outline





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